

Vishay Siliconix

P-Channel 40 V (D-S) MOSFET

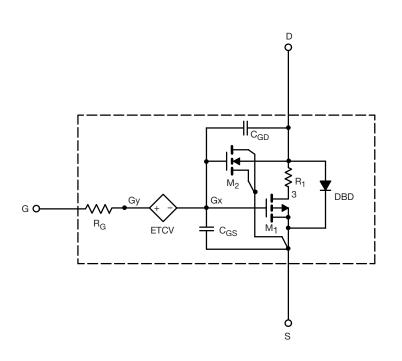
DESCRIPTION

The attached SPICE model describes the typical electrical characteristics of the p-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to + 125 °C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage. A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC

CHARACTERISTICS

- P-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the 55 °C to + 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics



Note

This document is intended as a SPICE modeling guideline and does not constitute a commercial product datasheet. Designers should refer to the appropriate datasheet of the same number for guaranteed specification limits.

SPICE Device Model SUD50P04-08

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SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted					
PARAMETER	SYMBOL	TEST CONDITIONS	SIMULATED DATA	MEASURED DATA	UNIT
Static			•		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=-250\;\mu A$	1.9	-	V
Drain-Source On-State Resistance ^a	Р	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -22 \text{ A}$	0.0068	0.0067	Ω
	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -19 \text{ A}$	0.010	0.0097	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 22 A	56	45	S
Diode Forward Voltage	V _{SD}	I _S = - 10 A	- 0.77	- 0.80	V
Dynamic ^b		·			
Input Capacitance	C _{iss}	V _{DS} = - 20 V, V _{GS} = 0 V, f = 1 MHz	5360	5380	pF
Output Capacitance	C _{oss}		568	570	
Reverse Transfer Capacitance	C _{rss}		498	500	
Total Gate Charge		$V_{DS} = -20 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -20 \text{ A}$	104	106	nC
	Qg	V_{DS} = - 20 V, V_{GS} = - 4.5 V, I_D = - 20 A	55	60	
Gate-Source Charge	Q _{gs}		22	22	
Gate-Drain Charge	Q _{gd}		27	27	

Notes

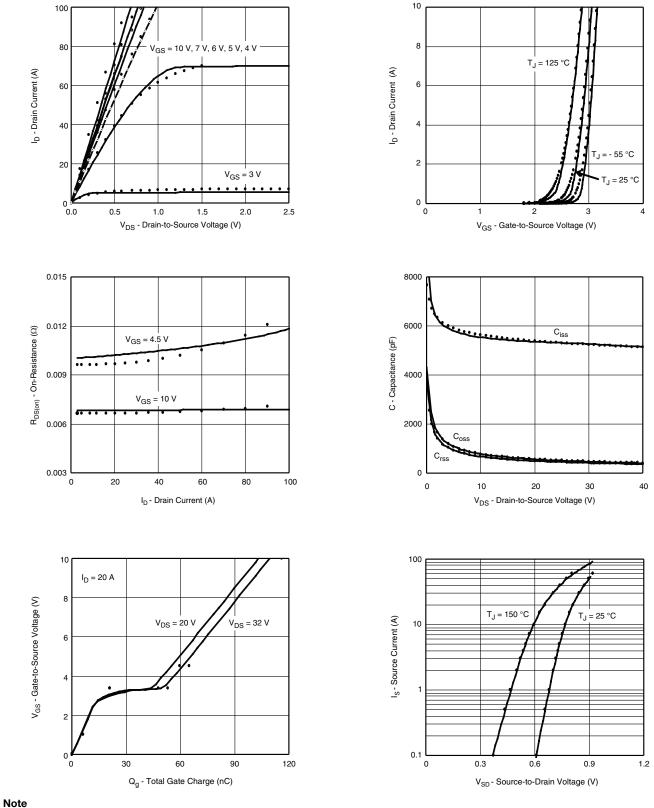
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.



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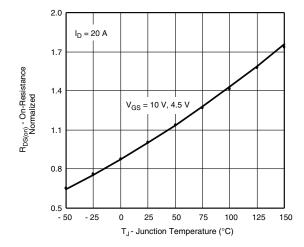


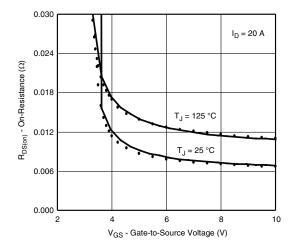
Dots and squares represent measured data.

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COMPARISON OF MODEL WITH MEASURED DATA T_J = 25 °C, unless otherwise noted





Note Dots and squares represent measured data.



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